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42390.P13267

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

LEASE ENTER K.N.

Filed: December 19, 2001 For:

UNDERFILL MATERIALS DISPENSED IN A FLIP CHIP PAČKAGE BY WAY OF A THROUGH HOLE

Serial No .:

Examiner:

Khiem Nguyen

In re Application of: Sambasivam, et al.

10/033,854

Group Art Unit: 2823

Attorney Docket No.: 42390.P13267

Confirmation No.: 9103

finareby certify that this correspondence is being facelitile tra to the United States Petent and Trademark Office att

## RESPONSE AFTER FINAL REJECTION

Commissioner for Patents P.O. Box 1450 Alexandra, VA 22313-1450

Sir:

In response to the Final Office Action mailed March 31, 2004, please consider the

following remarks:

Remarks/Arguments begin on page 2 of this paper